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April 2000

FDS9412

SEMICONDUCTOR IM

Single N-Channel Enhancement Mode Field Effect Transistor

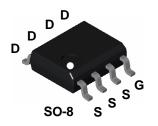
General Description

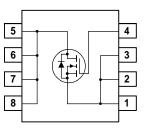
This N-Channel Logic Level MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

These devices are particularly suited for low voltage applications such as notebook computer DC-DC converter where fast switching, low conduction loss and high efficiency are needed.

Features

- 7.9 A, 30 V. $R_{DS(ON)} = 22 \ m\Omega \ @ V_{GS} = 10 \ V$ $R_{DS(ON)} = 36 \ m\Omega \ @ V_{GS} = 4.5 \ V$
- Very low gate charge.
- High switching speed
- + High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High power and current handling capability in a widely used surface mount package.





Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter			Ratings	Units
V _{DSS}	Drain-Sour	ain-Source Voltage		30	V
V _{GSS}	Gate-Source Voltage			±20	V
l _D	Drain Curre	ent – Continuous	(Note 1a)	7.9	А
– Pulsed				24	
P _D	Power Dissipation for Single Operation (Note 1a) 2.5		W		
			(Note 1b)	1.2	
			(Note 1c)	1.0	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C
			biopt (Net 4-)	50	
$R_{ heta JA}$		rmal Resistance, Junction-to-Ambient (Note 1a)		50	°C/W
R _{θJC}	Thermal Resistance, Junction-to-Case (Note 1)		SE (Note 1)	25	°C/W
Packag	e Markin	g and Ordering	Information		
Device Marking		Device	Reel Size	Tape width	Quantity
Device				12mm	2500 units

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V, I_D = 250 \ \mu A$	30			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		28		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24 V, V_{GS} = 0 V$			1	μA
I _{GSSF}	Gate-Body Leakage, Forward	Gate–Body Leakage, Forward $V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
I _{GSSR}	Gate-Body Leakage, Reverse	$V_{GS} = -20 V V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1	1.6	2.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		-4.3		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS} = 10 \; V, \;\; I_D = 7.9 \; A \\ V_{GS} = 10 \; V, \;\; I_D = 7.9 \; A, \; T_J \!=\! 125^\circ \! C \\ V_{GS} = 4.5 \; V, \;\; I_D = 6.2 \; A \end{array} $		19 30 25	22 35 36	mΩ
I _{D(on)}	On-State Drain Current	$V_{GS} = 10 \text{ V}, V_{DS} = 5 \text{ V}$	16			Α
g _{FS}	Forward Transconductance	$V_{DS} = 10 V$, $I_D = 7.9 A$		22		S
Dvnamio	Characteristics					
Ciss	Input Capacitance	$V_{DS} = 15 V$, $V_{GS} = 0 V$,		830		pF
Coss	Output Capacitance	f = 1.0 MHz		185		pF
C _{rss}	Reverse Transfer Capacitance			80		pF
Switchir	g Characteristics (Note 2)					
t _{d(on)}	Turn-On Delay Time	$V_{\text{DD}} = 10 \text{ V}, I_{\text{D}} = 1 \text{ A},$		6	12	ns
t _r	Turn–On Rise Time	$V_{GS} = 10$ V, $R_{GEN} = 6 \Omega$		10	20	ns
t _{d(off)}	Turn-Off Delay Time			18	32	ns
t _f	Turn–Off Fall Time	-		5	10	ns
Qq	Total Gate Charge	$V_{DS} = 12 V, I_D = 7.9 A,$		14	22	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 10 V$		2.7		nC
Q _{gd}	Gate-Drain Charge		-	3.0		nC
Drain-S	ource Diode Characteristics	and Maximum Ratings				
ls	Maximum Continuous Drain–Source				2	Α
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = 2 A$ (Note 2)		0.7	1.2	V



a) 50°/W when mounted on a 1in² pad of 2 oz copper

b) 105°/W when mounted on a .04 in² pad of 2 oz copper

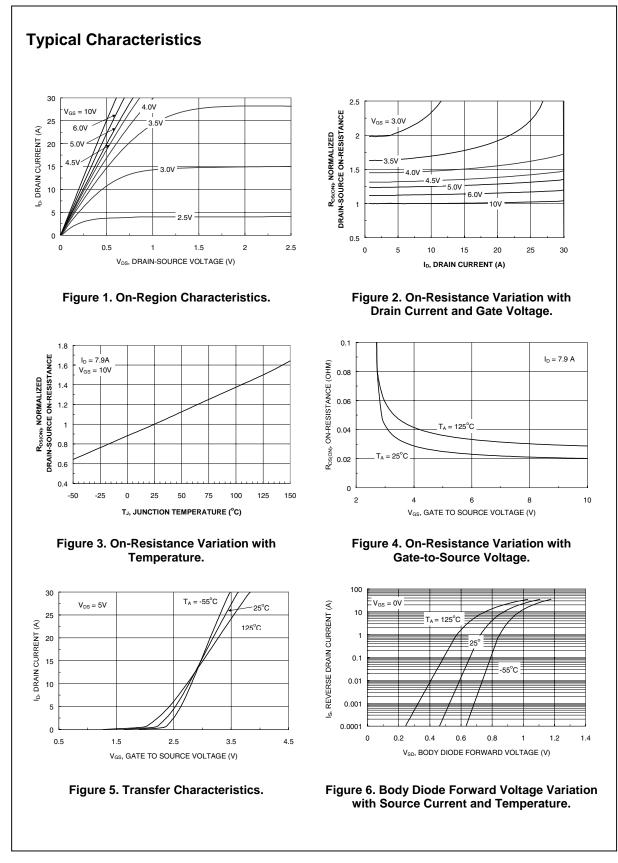
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c) 125°/W when mounted on a minimum pad.

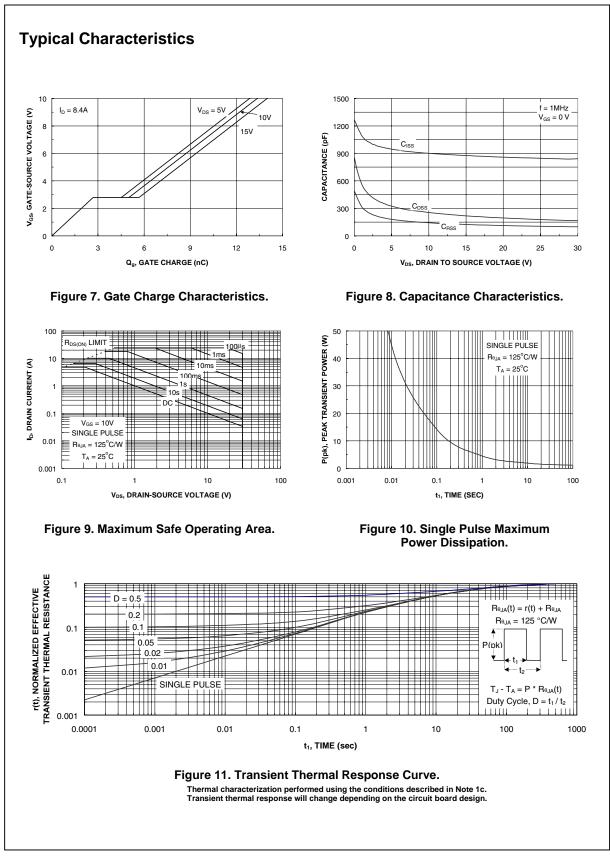
0000 Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%



FDS9412

FDS9412 Rev D(W)



FDS9412

FDS9412 Rev D(W)

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